Renesas Electronics America Inc - R5F5631ECDFC#V0 Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I²C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	133
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 21x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-LFQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631ecdfc-v0

Table 1.3 List of Products (2/8)

Group	Part No.	Package	ROM Capacity	RAM Capacity	E2 Data Flash	Operating Frequency (Max.)	Operating Temp. Range
RX63N (D version)	R5F563NDDDLK	PTLG0145KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDLK	PTLG0145KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDLK	PTLG0145KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDLK	PTLG0145KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDLK	PTLG0145KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFHDFB	PLQP0144KA-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFDDFB	PLQP0144KA-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKHDFB	PLQP0144KA-A*1	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKDDFB	PLQP0144KA-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDFB	PLQP0144KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDFB	PLQP0144KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJHDFB	PLQP0144KA-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJDDFB	PLQP0144KA-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGHDFB	PLQP0144KA-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGDDFB	PLQP0144KA-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDFB	PLQP0144KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDFB	PLQP0144KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYHDFB	PLQP0144KA-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYDDFB	PLQP0144KA-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWHDFB	PLQP0144KA-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWDDFB	PLQP0144KA-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDFB	PLQP0144KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDFB	PLQP0144KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDFB	PLQP0144KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDFB	PLQP0144KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDLJ	PTLG0100JA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDLJ	PTLG0100JA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDLJ	PTLG0100JA-A*1	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDLJ	PTLG0100JA-A*1	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDLJ	PTLG0100JA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDLJ	PTLG0100JA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDLJ	PTLG0100JA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDLJ	PTLG0100JA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFHDFP	PLQP0100KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFDDFP	PLQP0100KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKHDFP	PLQP0100KB-A*1	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKDDFP	PLQP0100KB-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDFP	PLQP0100KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDFP	PLQP0100KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJHDFP	PLQP0100KB-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJDDFP	PLQP0100KB-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGHDFP	PLQP0100KB-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGDDFP	PLQP0100KB-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDFP	PLQP0100KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDFP	PLQP0100KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C

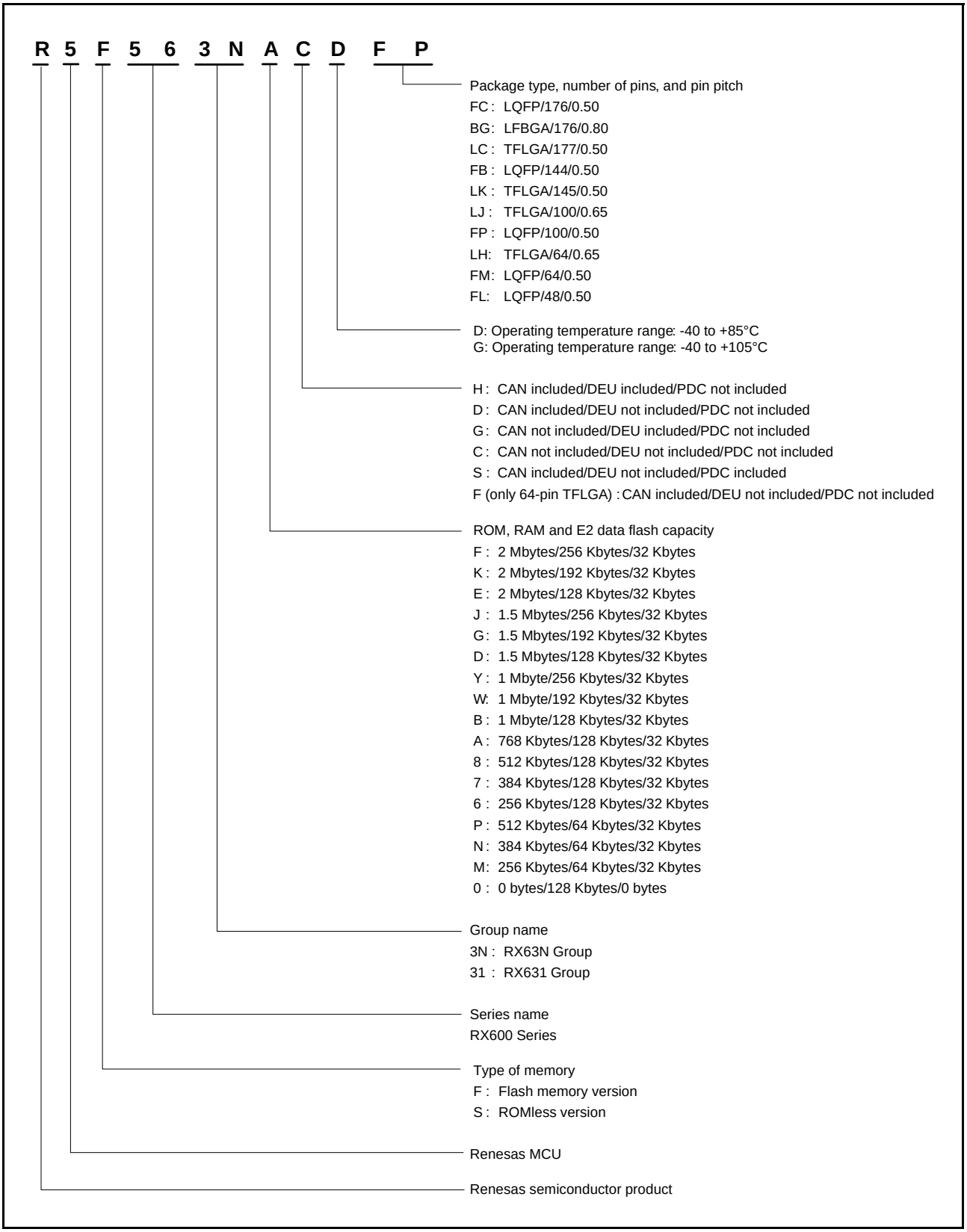


Figure 1.1 How to Read the Product Part No.

Table 1.4 Pin Functions (5/6)

Classifications	Pin Name	I/O	Description
Ethernet controller	ET_MDIO	I/O	Inputs or outputs bidirectional signals for exchange of management information between the RX63N Group and the PHY-LSI.
Parallel data capture unit (PDC)	PIXCLK	Input	Parallel data transfer clock
	VSYNC	Input	Vertical synchronization signal
	HSYNC	Input	Horizontal synchronization signal
	PIXD7 to PIXD0	Input	8-bit data
	PCKO	Output	Outputs parallel data transfer clock signal
USB power pins	VCC_USB	Input	Power supply pin. When the USB is not to be used, connect it to the VCC pin.
	VSS_USB	Input	Ground pin. When the USB is not to be used, connect it to the VSS pin.
USB 2.0 host/function module	USB0_DP, USB1_DP	I/O	Inputs or outputs USB transceiver D+ data.
	USB0_DM, USB1_DM	I/O	Inputs or outputs USB transceiver D- data.
	USB0_VBUS, USB1_VBUS	Input	Input pins for detection of connection and disconnection of the USB cable.
	USB0_EXICEN	Output	Output pin for control the low power of the OTG chip.
	USB0_VBUSEN	Output	Supply enable pin of VBUS (5 V) for the OTG chip.
	USB0_OVRCURA, USB0_OVRCURB,	Input	Input pin for detection of external over current.
	USB0_ID	Input	ID input pin of mini-AB connector at the OTG operation.
	USB0_DPUPE, USB1_DPUPE	Output	Pull-up control pins of the D+ signal at the function operation.
	USB0_DPRPD	Output	Pull-down control pins of the D+ signal at the host operation.
	USB0_DRPD	Output	Pull-down control pins of the D- signal at the host operation.
CAN module	CRX0 to CRX2	Input	Input pin.
	CTX0 to CTX2	Output	Output pin.
Serial peripheral interface	RSPCKA, RSPCKB RSPCKC	I/O	Clock input/output pin.
	MOSIA, MOSIB, MOSIC	I/O	Inputs or outputs data output from the master.
	MISOA, MISOB, MISOC	I/O	Inputs or outputs data output from the slave.
	SSLA0, SSLB0, SSLC0	I/O	Input or output pins slave selection
	SSLA1 to SSLA3 SSLB1 to SSLB3 SSLC1 to SSLC3	Output	Output pins slave selection
IEBus controller	IERXD	Input	Input pin for data reception.
	IETXD	Output	Output pin for data transmission.
Realtime clock	RTCOUT	Output	Output pin for 1-Hz clock.
	RTCIC0 to RTCIC2	Input	Time capture event input pin
12-bit A/D converter	AN000 to AN020	Input	Input pins for the analog signals to be processed by the A/D converter.
	ADTRG0#	Input	Input pins for the external trigger signals that start the A/D conversion.
10-bit A/D converter	AN0 to AN7	Input	Input pins for the analog signals to be processed by the A/D converter.
	ANEX0	Output	Extended analog output pin
	ANEX1	Input	Extended analog input pin
	ADTRG#	Input	Input pins for the external trigger signals that start the A/D conversion.
D/A converter	DA0, DA1	Output	Output pins for the analog signals to be processed by the D/A converter.

Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA) (1/5)

Pin No. 145-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
A1	AVSS0						
A2		P07				IRQ15	ADTRG0#
A3		P40				IRQ8-DS	AN000
A4		P42				IRQ10-DS	AN002
A5		P45				IRQ13-DS	AN005
A6		P90	A16		TXD7/SMOSI7/SSDA7		AN014
A7		P92	A18		RXD7/SMISO7/SSCL7		AN016
A8		PD2	D2[A2/D2]	MTIOC4D/TIOCA8	MISOC/CRX0	IRQ2	AN010
A9		PD6	D6[A6/D6]	MTIC5V/POE1#	SSLC2	IRQ6	AN6
A10	VSS						
A11		P62	CS2#/RAS#				
A12		PE1	D9[A9/D9]	MTIOC4C/TIOCD9/ PO18	TXD12/SMOSI12/SSDA12/ TXDX12/SIOX12/SSLB2/ RSPCKB		ANEX1
A13		PE3	D11[A11/D11]	MTIOC4B/TIOCB9/ PO26/POE8#	CTS12#/RTS12#/SS12#/ MISOB/ET_ERXD3		AN1
B1	VREFH						
B2	AVCC0						
B3		P05				IRQ13	DA1
B4	VREFL0						
B5		P43				IRQ11-DS	AN003
B6		P47				IRQ15-DS	AN007
B7		P91	A17		SCK7		AN015
B8		PD0	D0[A0/D0]	TIOCA7		IRQ0	AN008
B9		PD4	D4[A4/D4]	POE3#	SSLC0	IRQ4	AN012
B10	VCC						
B11		P61	CS1#/SDCS#				
B12		PE2	D10[A10/D10]	MTIOC4A/TIOCA9/ PO23	RXD12/SMISO12/SSCL12/ RXDX12/SSLB3/MOSIB	IRQ7-DS	AN0
B13		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ TIOCA10/PO28	SSLB0/ET_ERXD2		AN2
C1	VREFL						
C2		P02		TMCI1	SCK6	IRQ10	AN020
C3	VREFH0						
C4		P41				IRQ9-DS	AN001
C5		P46				IRQ14-DS	AN006
C6	VSS						
C7		PD1	D1[A1/D1]	MTIOC4B/TIOCB7/ TCLKG	MOSIC/CTX0	IRQ1	AN009
C8		PD3	D3[A3/D3]	TIOCB8/TCLKH/POE8#	RSPCKC	IRQ3	AN011
C9		PD7	D7[A7/D7]	MTIC5U/POE0#	SSLC3	IRQ7	AN7
C10		P63	CS3#/CAS#				
C11		PE0	D8[A8/D8]	TIOCC9	SCK12/SSLB1		ANEX0
C12	SDCLK	P70					
C13	VSS						
D1		P00		TMRI0	TXD6/SMOSI6/SSDA6	IRQ8	AN018
D2		PF5				IRQ4	
D3		P03				IRQ11	DA0
D4		P01		TMCI0	RXD6/SMISO6/SSCL6	IRQ9	AN019

Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA) (2/5)

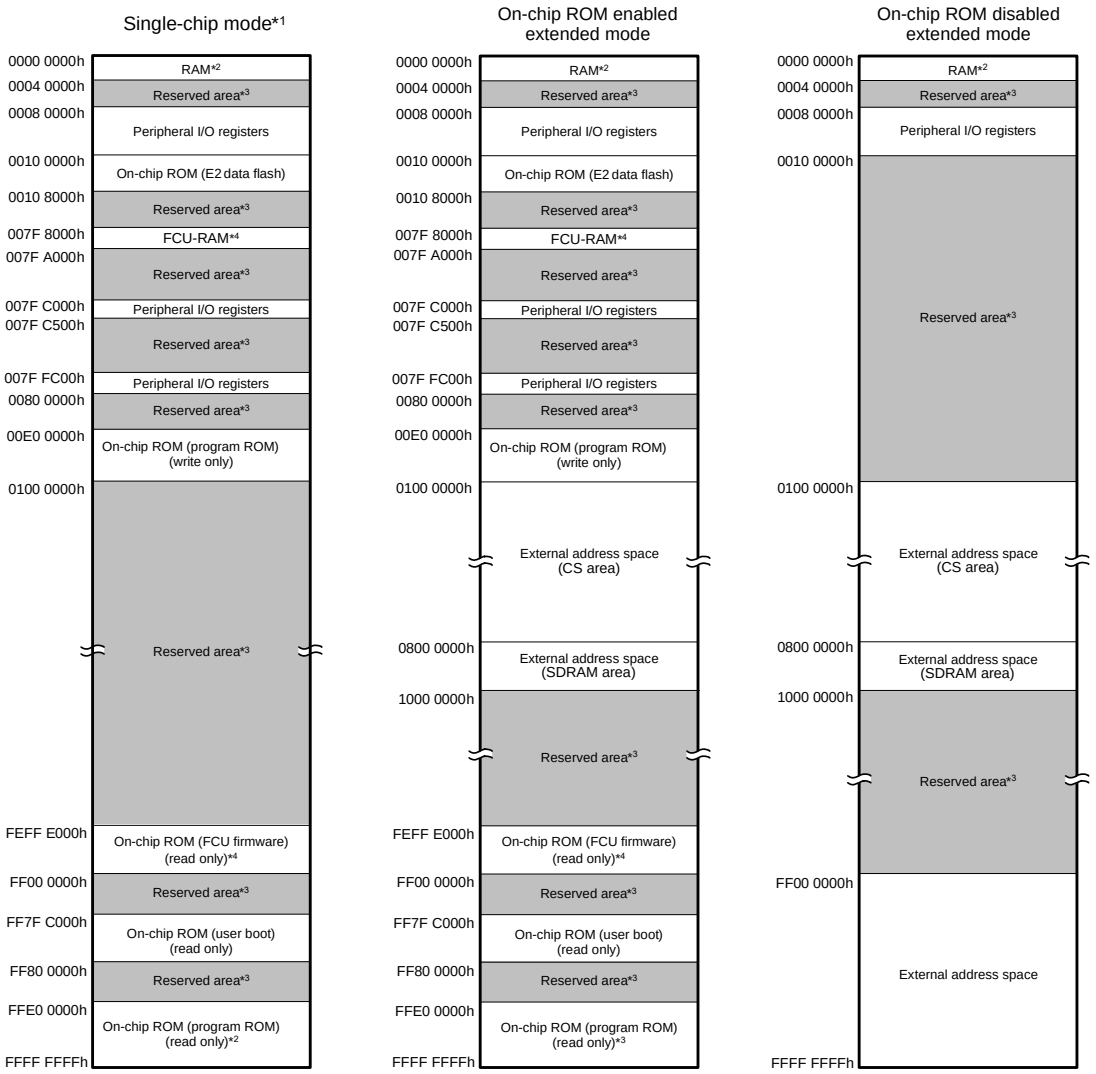
Pin No. 145-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
D5	VCC						
D6		P93	A19		CTS7#/RTS7#/SS7#		AN017
D7		PD5	D5[A5/D5]	MTIC5W/POE2#	SSLC1	IRQ5	AN013
D8		P60	CS0#				
D9		P64	CS4#/WE#				
D10		PE7	D15[A15/D15]	TIOCB11	MISOB	IRQ7	AN5
D11	VCC						
D12		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B/ TIOCB10	RSPCKB/ET_RX_CLK/ REF50CK	IRQ5	AN3
D13		PE6	D14[A14/D14]	TIOCA11	MOSIB	IRQ6	AN4
E1	VSS						
E2	VCL						
E3		PJ5					
E4	EMLE						
E5		P44				IRQ12-DS	AN004
E10		PA0	A0/BC0#	MTIOC4A/TIOCA0/ PO16	SSLA1/ET_TX_EN/ RMII_TXD_EN		
E11		P66	CS6#/DQM0		CTX2*2		
E12		P65	CS5#/CKE				
E13		P67	CS7#/DQM1		CRX2*2	IRQ15	
F1	XCIN						
F2	XCOUT						
F3		PJ3		MTIOC3C	CTS6#/RTS6#/CTS0#/ RTS0#/SS6#/SS0#		
F4	VBATT						
F10		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/SSCL5/ ET_MDIO	IRQ6-DS	
F11	VSS						
F12		PA1	A1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2/ET_WOL	IRQ11	
F13		PA2	A2	PO18	RXD5/SMISO5/SSCL5/ SSLA3		
G1	XTAL	P37					
G2	RES#						
G3	MD/FINED						
G4	BSCANP						
G10		PA5	A5	TIOCB1/PO21	RSPCKA/ET_LINKSTA		
G11		PA6	A6	MTIC5V/MTCLKB/ TIOCA2/TMCI3/PO22/ POE2#	CTS5#/RTS5#/SS5# MOSIA/ET_EXOUT		
G12	VCC						
G13		PA4	A4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0/ET_MDC	IRQ5-DS	
H1	EXTAL	P36					
H2	VCC						
H3	VSS						
H4		P35				NMI	
H10		P72	CS2#		ET_MDC		
H11		P71	CS1#		ET_MDIO		

Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA) (5/5)

Pin No. 145-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
N7	TRDATA3	P55	WAIT#/ EDREQ0	MTIOC4D/TMO3	CRX1/ET_EXOUT	IRQ10	
N8	VSS						
N9		PC7	A23/CS0#	MTIOC3A/MTCLKB/ TIOCB6/TMO2/PO31	TXD8/SMOSI8/SSDA8/ MISOA/ET_COL	IRQ14	
N10	TRSYNC	P82	EDREQ1	MTIOC4A/PO28	TXD10/SMOSI10/SSDA10/ ET_ETXD1/RMII_TXD1		
N11		PC3	A19	MTIOC4D/TCLKB/PO24	TXD5/SMOSI5/SSDA5/ IETXD/ET_TX_ER		
N12		P75	CS5#	PO20	SCK11/ET_ERXD0/ RMII_RXD0		
N13		P74	CS4#	PO19	CTS11#/RTS11#/SS11#/ ET_ERXD1/RMII_RXD1		

Note 1. The BCLK function is multiplexed with the I/O port function for pin P53, so the port function is not available if the external bus is enabled.

Note 2. Enabled only for the ROM capacity: 2 Mbytes/1.5 Mbytes



Note 1. The address space in boot mode and user boot mode/USB boot mode is the same as the address space in single-chip mode.
Note 2. The capacity of ROM/RAM differs depending on the products.

ROM (byt)			RAM (byt)	
Capacity	**Address (for reading only)**	**Address (for programming only)**	**Capacity**	**Address**
2 M	FFE0 0000h to FFFF FFFFh	00E0 0000h to 00FF FFFFh	256 K	0000 0000h to 0003 FFFFh
			192 K	0000 0000h to 0002 FFFFh
			128 K	0000 0000h to 0001 FFFFh
1.5 M	FFE8 0000h to FFFF FFFFh	00E8 0000h to 00FF FFFFh	256 K	0000 0000h to 0003 FFFFh
			192 K	0000 0000h to 0002 FFFFh
			128 K	0000 0000h to 0001 FFFFh
1 M	FFF0 0000h to FFFF FFFFh	00F0 0000h to 00FF FFFFh	256 K	0000 0000h to 0003 FFFFh
			192 K	0000 0000h to 0002 FFFFh
			128 K	0000 0000h to 0001 FFFFh
768 K	FFF4 0000h to FFFF FFFFh	00F4 0000h to 00FF FFFFh		
512K	FFF8 0000h to FFFF FFFFh	00F8 0000h to 00FF FFFFh		
384K	FFFA 0000h to FFFF FFFFh	00FA 0000h to 00FF FFFFh		
256K	FFFC 0000h to FFFF FFFFh	00FC 0000h to 00FF FFFFh		
512K	FFF8 0000h to FFFF FFFFh	00F8 0000h to 00FF FFFFh	64K	0000 0000h to 0000 FFFFh
384K	FFFA 0000h to FFFF FFFFh	00FA 0000h to 00FF FFFFh		
256K	FFFC 0000h to FFFF FFFFh	00FC 0000h to 00FF FFFFh		

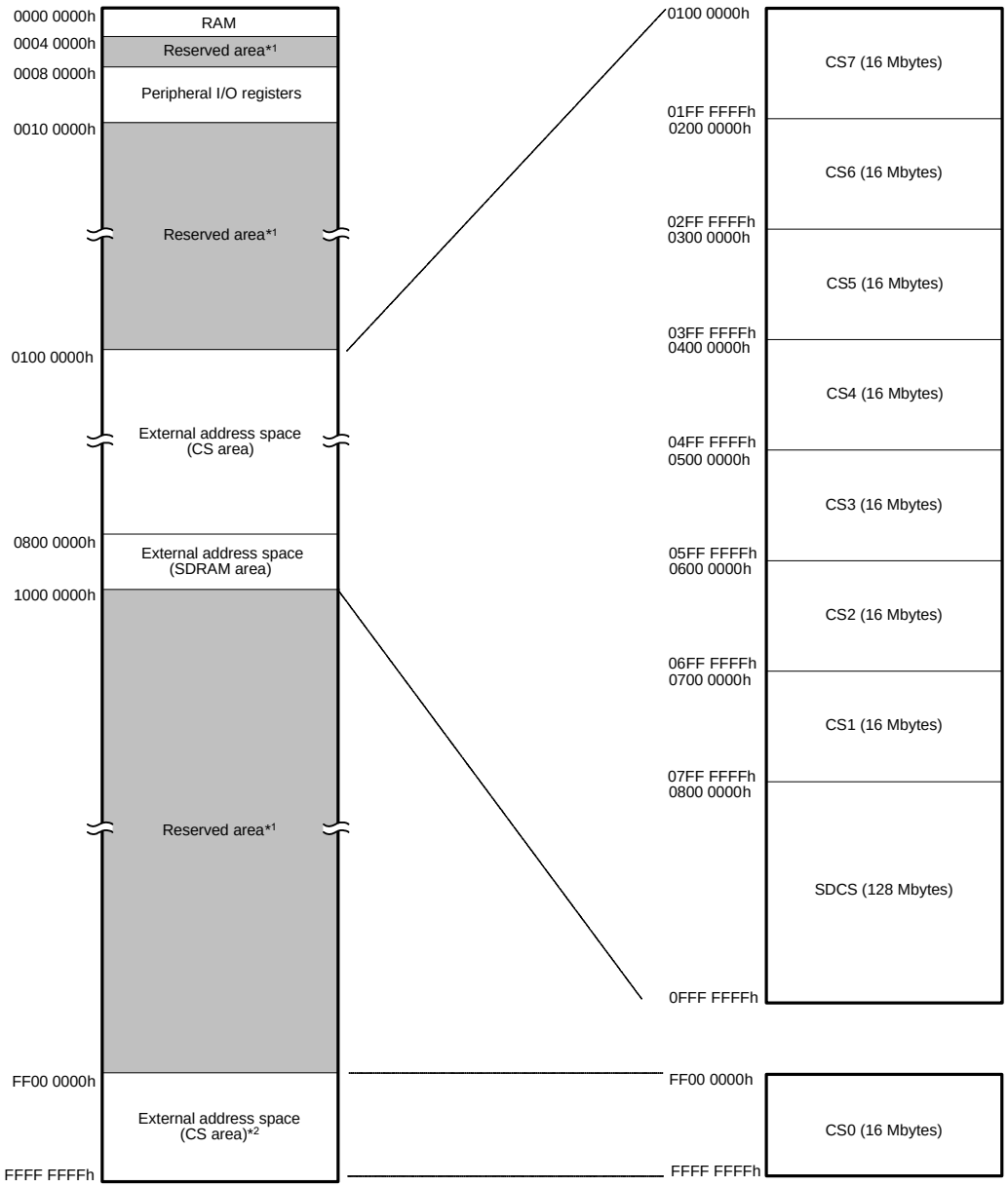
Note:See Table 1.3, List of Products, for the product type name.

Note 3. Reserved areas should not be accessed.
Note 4. For details on the FCU, see section 47, Flash Memory in the User's manual: Hardware.

Figure 3.1 Memory Map in Each Operating Mode

3.2 External Address Space

The external address space is classified into CS areas (CS0 to CS7) and SDRAM area (SDCS). CS areas can be divided into up to eight areas (CS0 to SC7) corresponding to the CSn# signal to be output from the CSn# pin.
Figure 3.2 shows the address ranges corresponding to the individual CS areas (CS0 to CS7) and SDRAM area (SDCS) in on-chip ROM disabled extended mode.



Note 1. Reserved areas should not be accessed.
Note 2. The CS0 area is disabled in on-chip ROM enabled extended mode.
In this mode, the address space for addresses above 1000 0000h is as shown in figure on this section, Memory Map in Each Operating Mode.

Figure 3.2 Correspondence between External Address Spaces and CS Areas (In On-Chip ROM Disabled Extended Mode)

Table 4.1 List of I/O Registers (Address Order) (2/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 201Ch	DMAC0	DMA transfer enable register	DMCNT	8	8	2 ICLK		DMACA
0008 201Dh	DMAC0	DMA software start register	DMREQ	8	8	2 ICLK		DMACA
0008 201Eh	DMAC0	DMA status register	DMSTS	8	8	2 ICLK		
0008 201Fh	DMAC0	DMA activation source flag control register	DMCSL	8	8	2 ICLK		
0008 2040h	DMAC1	DMA source address register	DMSAR	32	32	2 ICLK		
0008 2044h	DMAC1	DMA destination address register	DMDAR	32	32	2 ICLK		
0008 2048h	DMAC1	DMA transfer count register	DMCRA	32	32	2 ICLK		
0008 204Ch	DMAC1	DMA block transfer count register	DMCRB	16	16	2 ICLK		
0008 2050h	DMAC1	DMA transfer mode register	DMTMD	16	16	2 ICLK		
0008 2053h	DMAC1	DMA interrupt setting register	DMINT	8	8	2 ICLK		
0008 2054h	DMAC1	DMA address mode register	DMAMD	16	16	2 ICLK		
0008 205Ch	DMAC1	DMA transfer enable register	DMCNT	8	8	2 ICLK		
0008 205Dh	DMAC1	DMA software start register	DMREQ	8	8	2 ICLK		
0008 205Eh	DMAC1	DMA status register	DMSTS	8	8	2 ICLK		
0008 205Fh	DMAC1	DMA activation source flag control register	DMCSL	8	8	2 ICLK		
0008 2080h	DMAC2	DMA source address register	DMSAR	32	32	2 ICLK		
0008 2084h	DMAC2	DMA destination address register	DMDAR	32	32	2 ICLK		
0008 2088h	DMAC2	DMA transfer count register	DMCRA	32	32	2 ICLK		
0008 208Ch	DMAC2	DMA block transfer count register	DMCRB	16	16	2 ICLK		
0008 2090h	DMAC2	DMA transfer mode register	DMTMD	16	16	2 ICLK		
0008 2093h	DMAC2	DMA interrupt setting register	DMINT	8	8	2 ICLK		
0008 2094h	DMAC2	DMA address mode register	DMAMD	16	16	2 ICLK		
0008 209Ch	DMAC2	DMA transfer enable register	DMCNT	8	8	2 ICLK		
0008 209Dh	DMAC2	DMA software start register	DMREQ	8	8	2 ICLK		
0008 209Eh	DMAC2	DMA status register	DMSTS	8	8	2 ICLK		
0008 209Fh	DMAC2	DMA activation source flag control register	DMCSL	8	8	2 ICLK		
0008 20C0h	DMAC3	DMA source address register	DMSAR	32	32	2 ICLK		
0008 20C4h	DMAC3	DMA destination address register	DMDAR	32	32	2 ICLK		
0008 20C8h	DMAC3	DMA transfer count register	DMCRA	32	32	2 ICLK		
0008 20CCh	DMAC3	DMA block transfer count register	DMCRB	16	16	2 ICLK		
0008 20D0h	DMAC3	DMA transfer mode register	DMTMD	16	16	2 ICLK		
0008 20D3h	DMAC3	DMA interrupt setting register	DMINT	8	8	2 ICLK		
0008 20D4h	DMAC3	DMA address mode register	DMAMD	16	16	2 ICLK		
0008 20DCh	DMAC3	DMA transfer enable register	DMCNT	8	8	2 ICLK		
0008 20DDh	DMAC3	DMA software start register	DMREQ	8	8	2 ICLK		
0008 20DEh	DMAC3	DMA status register	DMSTS	8	8	2 ICLK		
0008 20DFh	DMAC3	DMA activation source flag control register	DMCSL	8	8	2 ICLK		
0008 2200h	DMAC	DMACA module activation register	DMAST	8	8	2 ICLK		
0008 2400h	DTC	DTC control register	DTCCR	8	8	2 ICLK		DTCa
0008 2404h	DTC	DTC vector base register	DTCVBR	32	32	2 ICLK		
0008 2408h	DTC	DTC address mode register	DTCADMOD	8	8	2 ICLK		
0008 240Ch	DTC	DTC module start register	DTCST	8	8	2 ICLK		
0008 240Eh	DTC	DTC status register	DTCSTS	16	16	2 ICLK		
0008 2800h	EXDMAC0	EXDMA source address register	EDMSAR	32	32	1, 2 BCLK		EXDMACa
0008 2804h	EXDMAC0	EXDMA destination address register	EDMDAR	32	32	1, 2 BCLK		
0008 2808h	EXDMAC0	EXDMA transfer count register	EDMCRA	32	32	1, 2 BCLK		
0008 280Ch	EXDMAC0	EXDMA block transfer count register	EDMCRB	16	16	1, 2 BCLK		
0008 2810h	EXDMAC0	EXDMA transfer mode register	EDMTMD	16	16	1, 2 BCLK		
0008 2812h	EXDMAC0	EXDMA output setting register	EDMOMD	8	8	1, 2 BCLK		
0008 2813h	EXDMAC0	EXDMA interrupt setting register	EDMINT	8	8	1, 2 BCLK		
0008 2814h	EXDMAC0	EXDMA address mode register	EDMAMD	32	32	1, 2 BCLK		

Table 4.1 List of I/O Registers (Address Order) (18/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 8200h	TMR0	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 8201h	TMR1	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8202h	TMR0	Timer control/status register	TCSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8203h	TMR1	Timer control/status register	TCSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8204h	TMR0	Time constant register A	TCORA	8	8	2, 3 PCLKB	2 ICLK	
0008 8205h	TMR1	Time constant register A	TCORA	8	8*5	2, 3 PCLKB	2 ICLK	
0008 8206h	TMR0	Time constant register B	TCORB	8	8	2, 3 PCLKB	2 ICLK	
0008 8207h	TMR1	Time constant register B	TCORB	8	8*5	2, 3 PCLKB	2 ICLK	
0008 8208h	TMR0	Timer counter	TCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 8209h	TMR1	Timer counter	TCNT	8	8*5	2, 3 PCLKB	2 ICLK	
0008 820Ah	TMR0	Timer counter control register	TCCR	8	8	2, 3 PCLKB	2 ICLK	
0008 820Bh	TMR1	Timer counter control register	TCCR	8	8*5	2, 3 PCLKB	2 ICLK	
0008 8210h	TMR2	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8211h	TMR3	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8212h	TMR2	Timer control/status register	TCSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8213h	TMR3	Timer control/status register	TCSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8214h	TMR2	Time constant register A	TCORA	8	8	2, 3 PCLKB	2 ICLK	
0008 8215h	TMR3	Time constant register A	TCORA	8	8*5	2, 3 PCLKB	2 ICLK	
0008 8216h	TMR2	Time constant register B	TCORB	8	8	2, 3 PCLKB	2 ICLK	
0008 8217h	TMR3	Time constant register B	TCORB	8	8	2, 3 PCLKB	2 ICLK	
0008 8218h	TMR2	Timer counter	TCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 8219h	TMR3	Timer counter	TCNT	8	8*5	2, 3 PCLKB	2 ICLK	
0008 821Ah	TMR2	Timer counter control register	TCCR	8	8	2, 3 PCLKB	2 ICLK	
0008 821Bh	TMR3	Timer counter control register	TCCR	8	8*5	2, 3 PCLKB	2 ICLK	
0008 8280h	CRC	CRC control register	CRCCR	8	8	2, 3 PCLKB	2 ICLK	CRC
0008 8281h	CRC	CRC data input register	CRCDIR	8	8	2, 3 PCLKB	2 ICLK	
0008 8282h	CRC	CRC data output register	CRCDOR	16	16	2, 3 PCLKB	2 ICLK	
0008 8300h	RIIC0	I^2C bus control register 1	ICCR1	8	8	2, 3 PCLKB	2 ICLK	RIIC
0008 8301h	RIIC0	I^2C bus control register 2	ICCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8302h	RIIC0	I^2C bus mode register 1	ICMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8303h	RIIC0	I^2C bus mode register 2	ICMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8304h	RIIC0	I^2C bus mode register 3	ICMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 8305h	RIIC0	I^2C bus function enable register	ICFER	8	8	2, 3 PCLKB	2 ICLK	
0008 8306h	RIIC0	I^2C bus status enable register	ICSER	8	8	2, 3 PCLKB	2 ICLK	
0008 8307h	RIIC0	I^2C bus interrupt enable register	ICIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8308h	RIIC0	I^2C bus status register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8309h	RIIC0	I^2C bus status register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK	
0008 830Ah	RIIC0	Slave address register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK	
0008 830Ah	RIIC0	Timeout Internal Counter L	TMOCNTL	8	8	2, 3 PCLKB	2 ICLK	
0008 830Bh	RIIC0	Slave address register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK	
0008 830Bh	RIIC0	Timeout Internal Counter U	TMOCNTU	8	8	2, 3 PCLKB	2 ICLK	
0008 830Ch	RIIC0	Slave address register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK	
0008 830Dh	RIIC0	Slave address register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK	
0008 830Eh	RIIC0	Slave address register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK	
0008 830Fh	RIIC0	Slave address register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK	
0008 8310h	RIIC0	I^2C bus bit rate low-level register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	
0008 8311h	RIIC0	I^2C bus bit rate high-level register	ICBRH	8	8	2, 3 PCLKB	2 ICLK	
0008 8312h	RIIC0	I^2C bus transmit data register	ICDRT	8	8	2, 3 PCLKB	2 ICLK	

Table 5.4 DC Characteristics (3) (for D and G Versions (-40 ≤ Ta ≤ +85°C))

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RAM standby voltage	V_{RAM}	2.7	—	—	V	
VCC rising gradient	SrVCC	8.4	—	20000	µs/V	
VCC falling gradient*8	SfVCC	8.4	—	—	µs/V	

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.
Note 2. Measured with clocks supplied to the peripheral functions. This does not include the BGO operation.
Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK:PCLK:BCLK:BCLK pin = 8:4:4:2)
I_{CC} Max. = 0.87 × f + 13 (max. operation in high-speed operating mode)
I_{CC} Typ. = 0.35 × f + 5 (normal operation in high-speed operating mode)
I_{CC} Typ. = 1.0 × f + 3 (low-speed operating mode 1)
I_{CC} Max. = 0.53 × f + 12 (sleep mode)
Note 4. This does not include the BGO operation.
Note 5. This is the increase for programming or erasure of the ROM or flash memory for data storage during program execution.
Note 6. Supply of the clock signal to peripherals is stopped in this state. This does not include the BGO operation.
Note 7. The reference power supply current is included in the power supply current value for 10-bit A/D conversion and D/A conversion.
Note 8. When V_{BATT} is used
Note 9. The current values for 10-bit A/D converter and 10-bit D/A converter are included in the current from the VREFH pin.
Note 10. The values are the sum of I_{AVCC0} and I_{VREFH}.

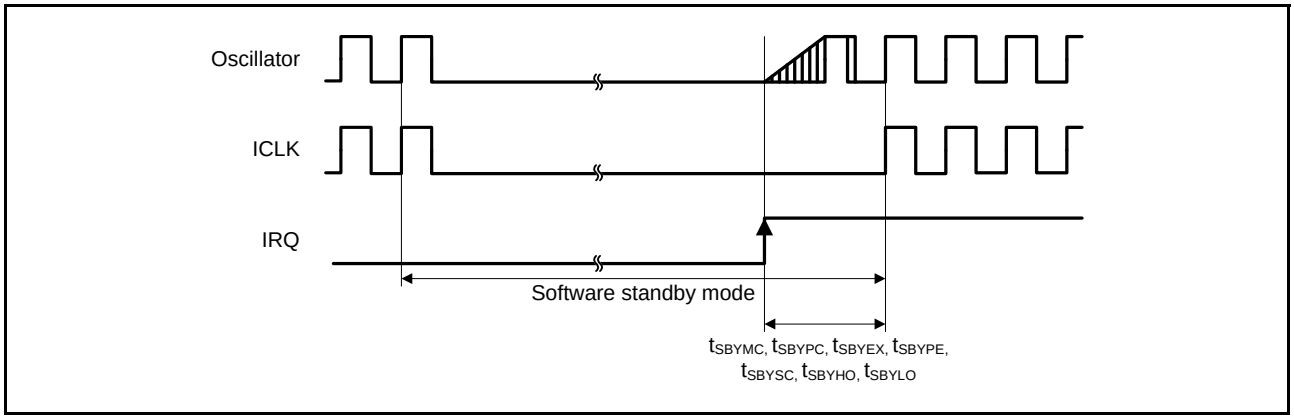


Figure 5.13 Software Standby Mode Cancellation Timing

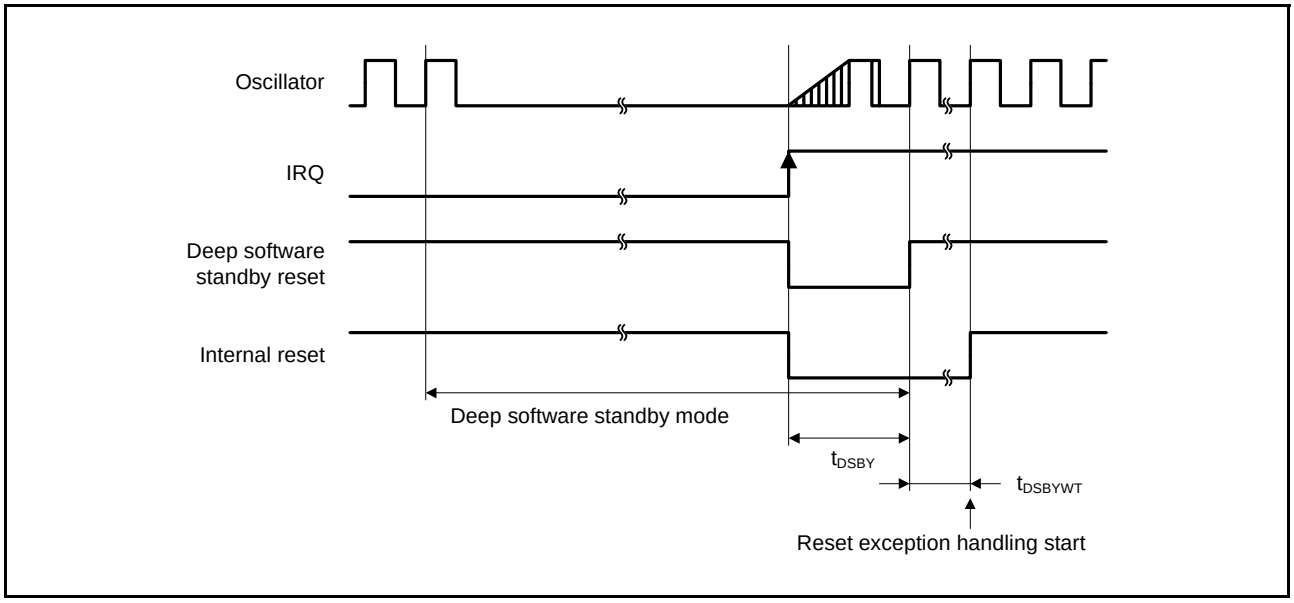


Figure 5.14 Deep Software Standby Mode Cancellation Timing

5.3.4 Control Signal Timing

Table 5.15 Control Signal Timing

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
NMI pulse width	t_{NMIW}	200	—	—	ns	tc (PCLK) × 2 ≤ 200 ns Figure 5.15
		tc (PCLK) × 2				tc (PCLK) × 2 > 200 ns Figure 5.15
IRQ pulse width	t_{IRQW}	200	—	—	ns	tc (PCLK) × 2 ≤ 200 ns Figure 5.16
		tc (PCLK) × 2				tc (PCLK) × 2 > 200 ns Figure 5.16

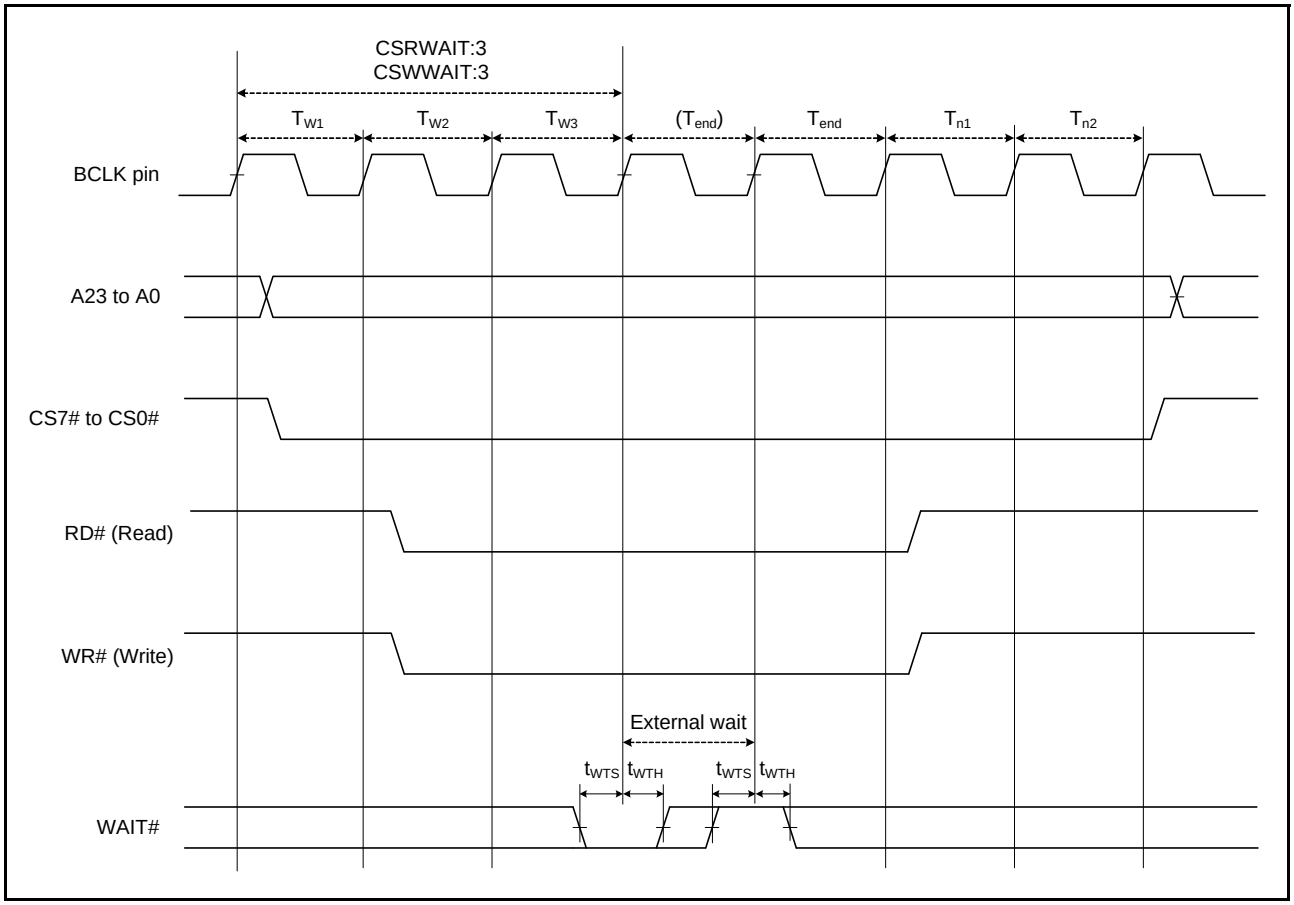
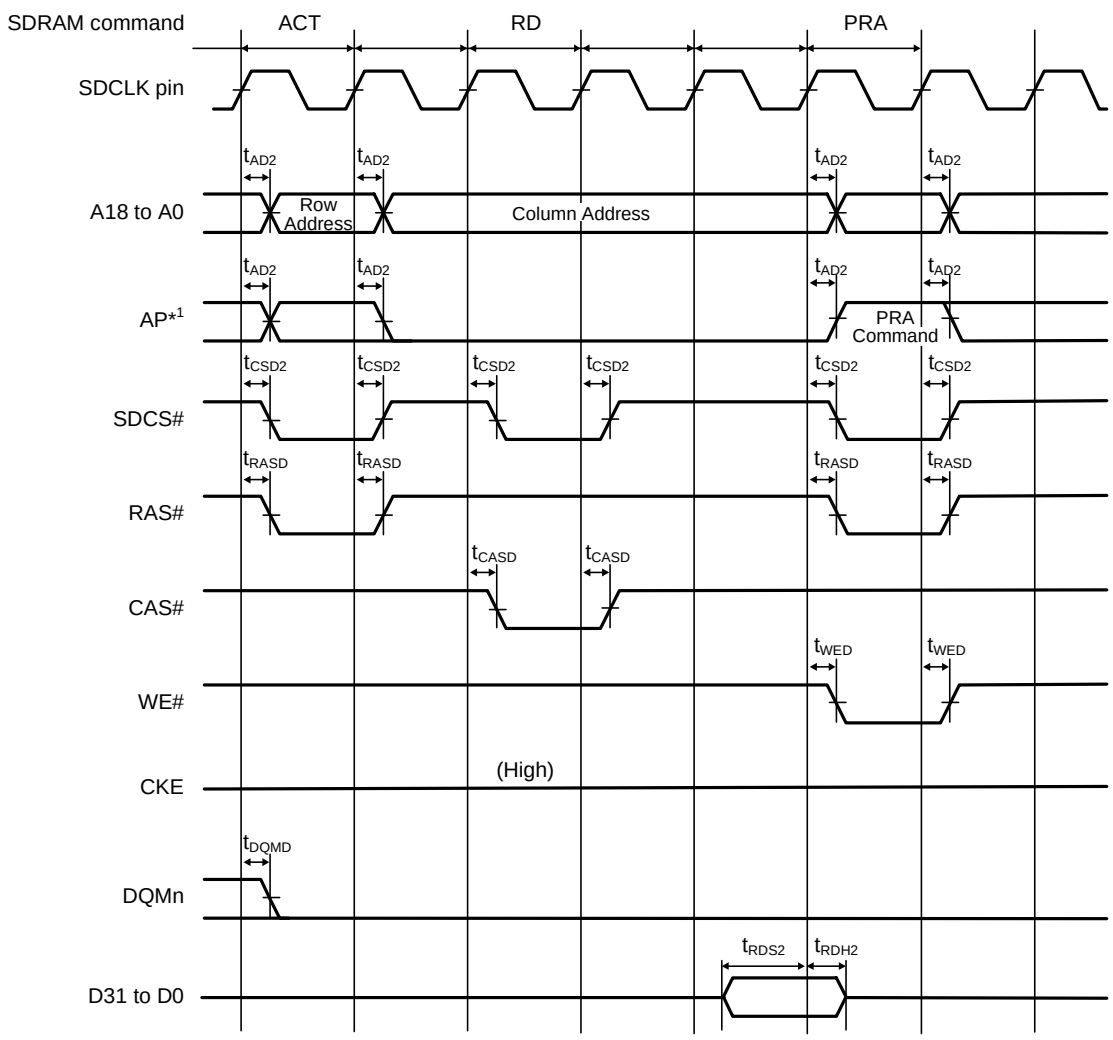


Figure 5.23 External Bus Timing/External Wait Control



Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.24 SDRAM Space Single Read Bus Timing

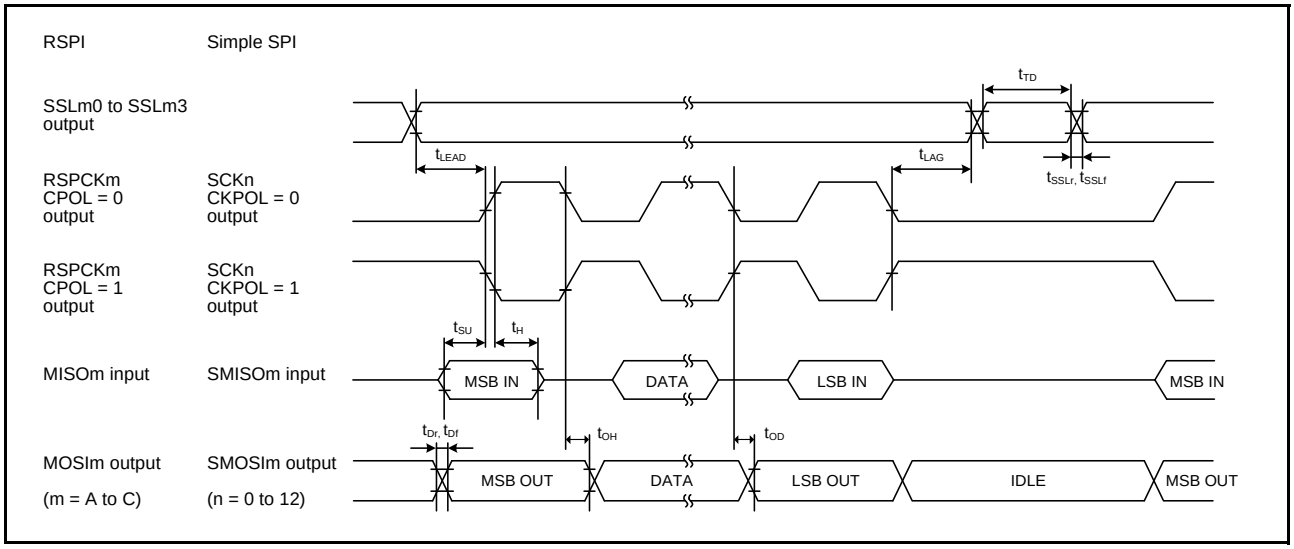


Figure 5.43 RSPI Timing (Master, CPHA = 0) and Simple SPI Timing (Master, CKPH = 1)

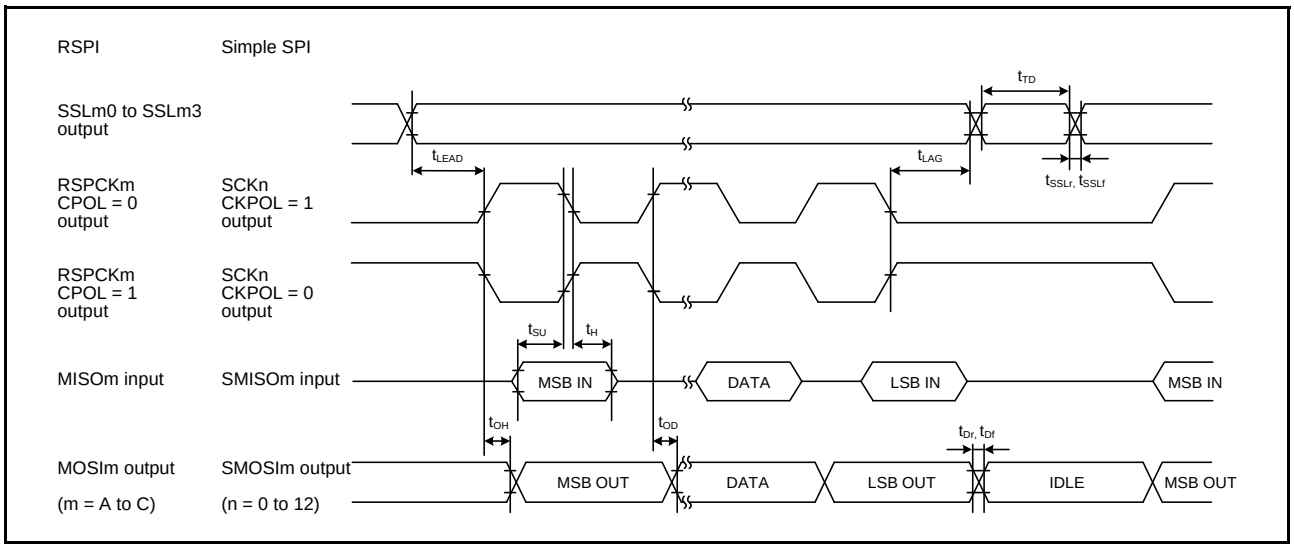


Figure 5.44 RSPI Timing (Master, CPHA = 1) and Simple SPI Timing (Master, CKPH = 0)

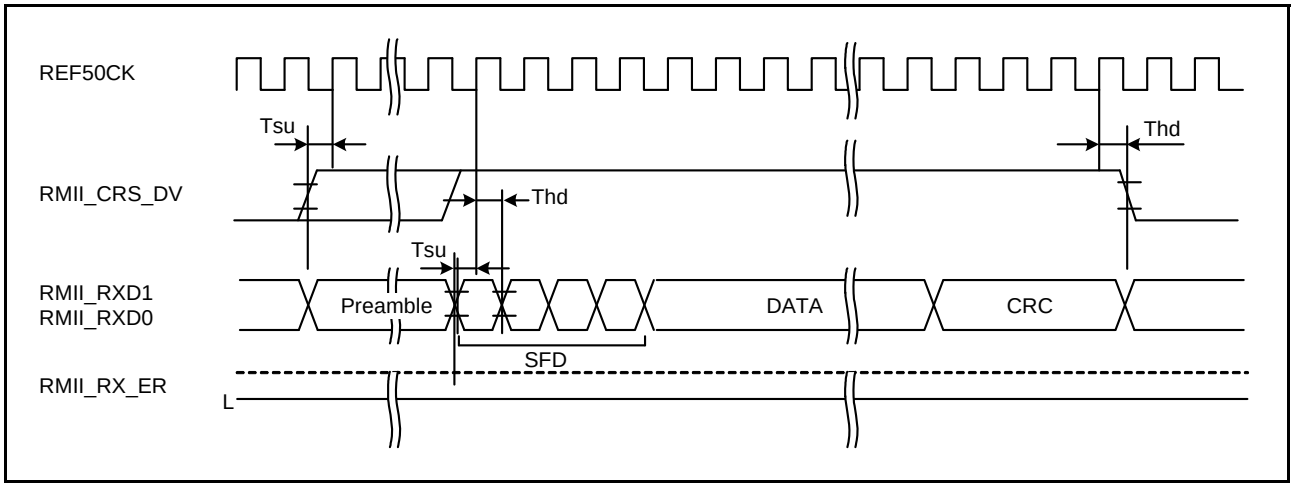


Figure 5.50 RMII Reception Timing (Normal Operation)

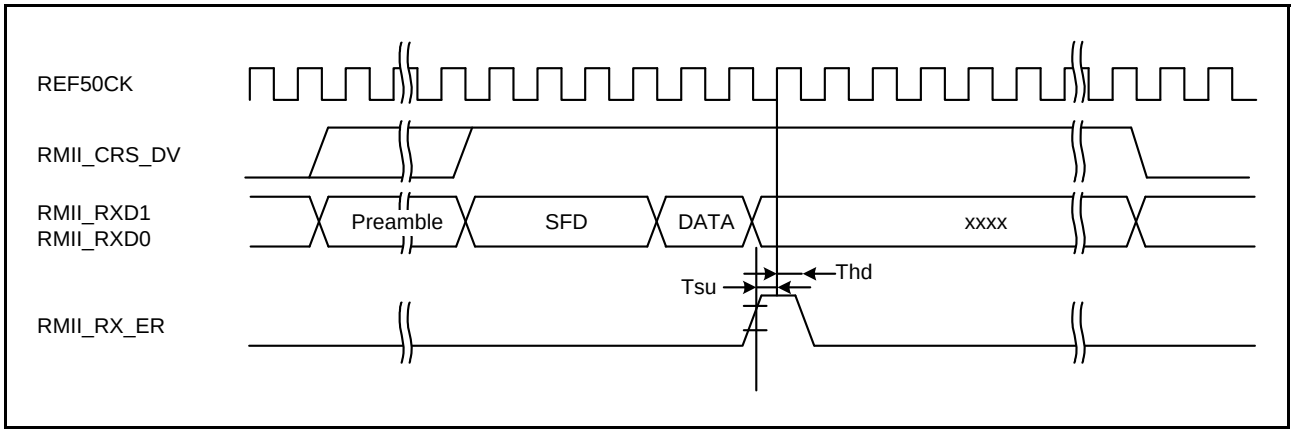


Figure 5.51 RMII Reception Timing (Error Occurrence)

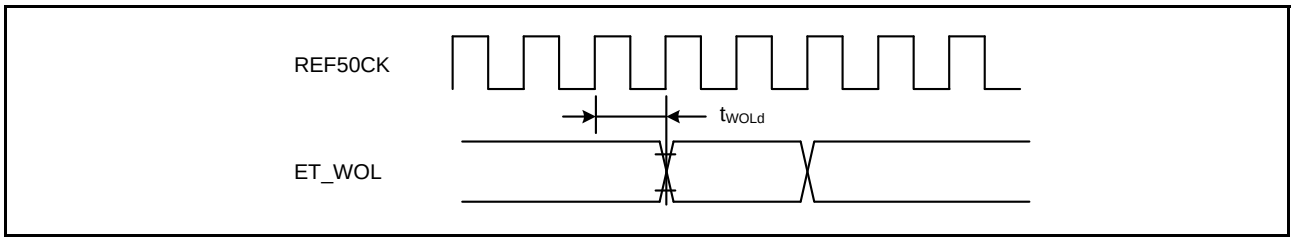


Figure 5.52 WOL Output Timing (RMII)

5.4 USB Characteristics

Table 5.27 On-Chip USB Full-Speed Characteristics (DP and DM Pin Characteristics)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
PCLK = 24 to 50 MHz
$T_a = T_{opr}$
High drive output is selected by the drive capacity control register.

Item		Symbol	Min.	Max.	Unit	Test Conditions	
Input characteristics	Input high level voltage	V_{IH}	2.0	—	V		
	Input low level voltage	V_{IL}	—	0.8	V		
	Differential input sensitivity	V_{DI}	0.2	—	V	| DP – DM |	
	Differential common mode range	V_{CM}	0.8	2.5	V		
Output characteristics	Output high level voltage	V_{OH}	2.8	3.6	V	I_{OH} = –200 µA	
	Output low level voltage	V_{OL}	0.0	0.3	V	I_{OL} = 2 mA	
	Cross-over voltage	V_{CRS}	1.3	2.0	V		Figure 5.61
	Rise time	t_{Lr}	4	20	ns		
	Fall time	t_{Lf}	4	20	ns		
	Rise/fall time ratio	t_{Lr} / t_{Lf}	90	111.11	%	t_{Lr} / t_{Lf}	
	Output resistance	Z_{DRV}	28	44	Ω	Rs = 22 Ω included	

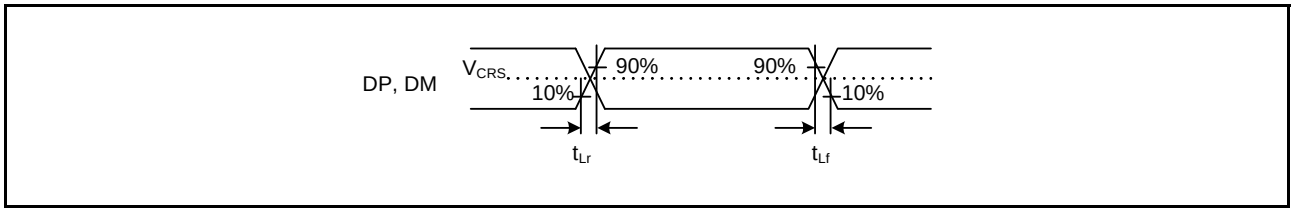


Figure 5.61 DP and DM Output Timing (Full-Speed)

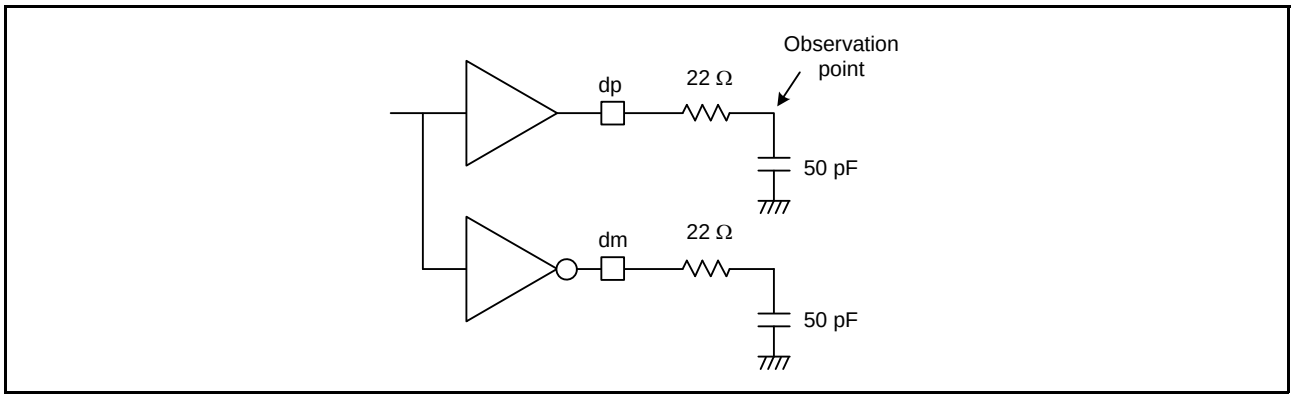


Figure 5.62 Test Circuit (Full-Speed)

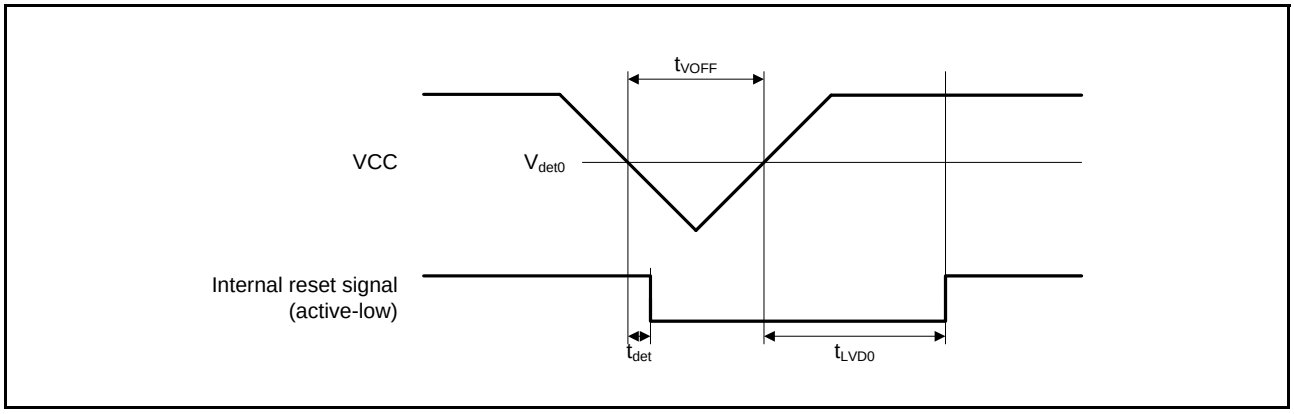


Figure 5.64 Voltage Detection Circuit Timing (V_{det0})

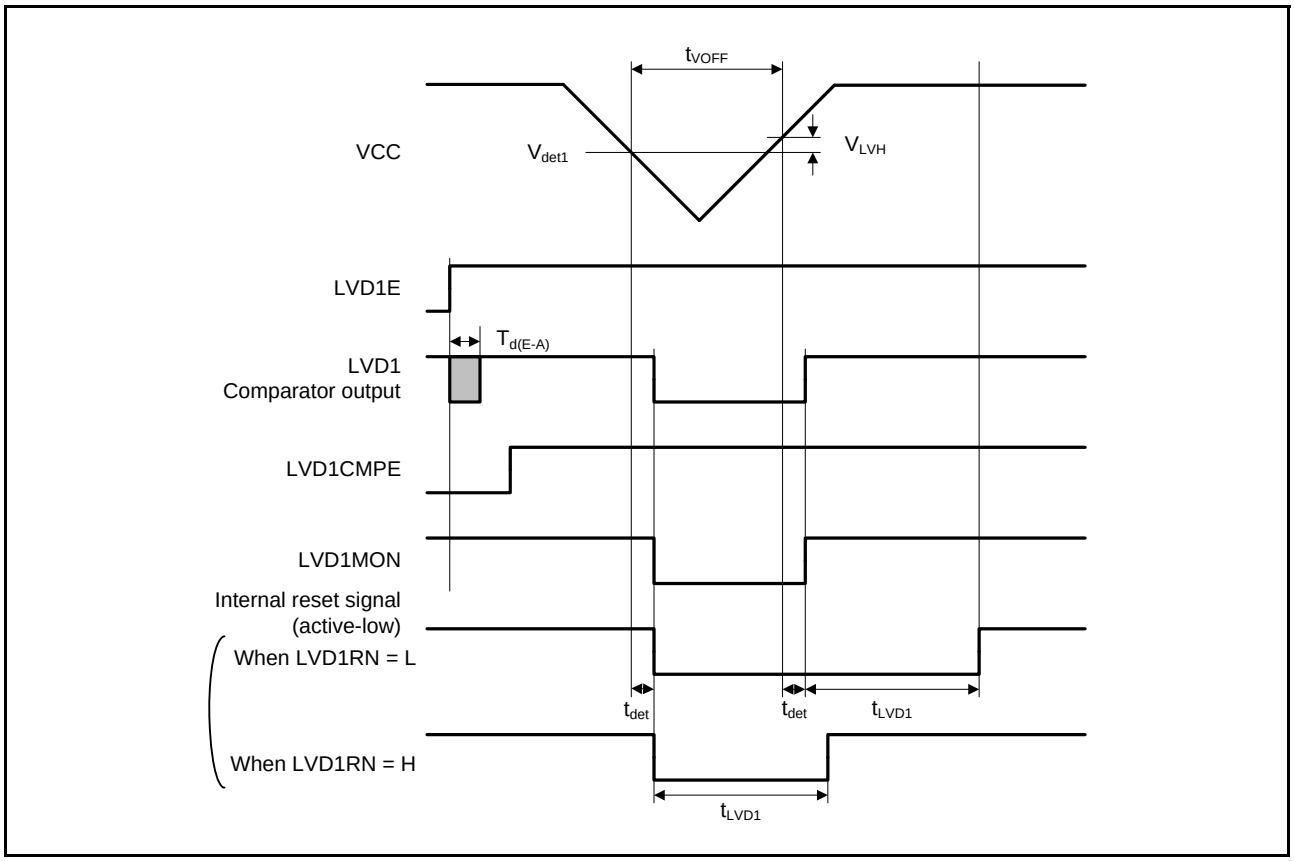


Figure 5.65 Voltage Detection Circuit Timing (V_{det1})

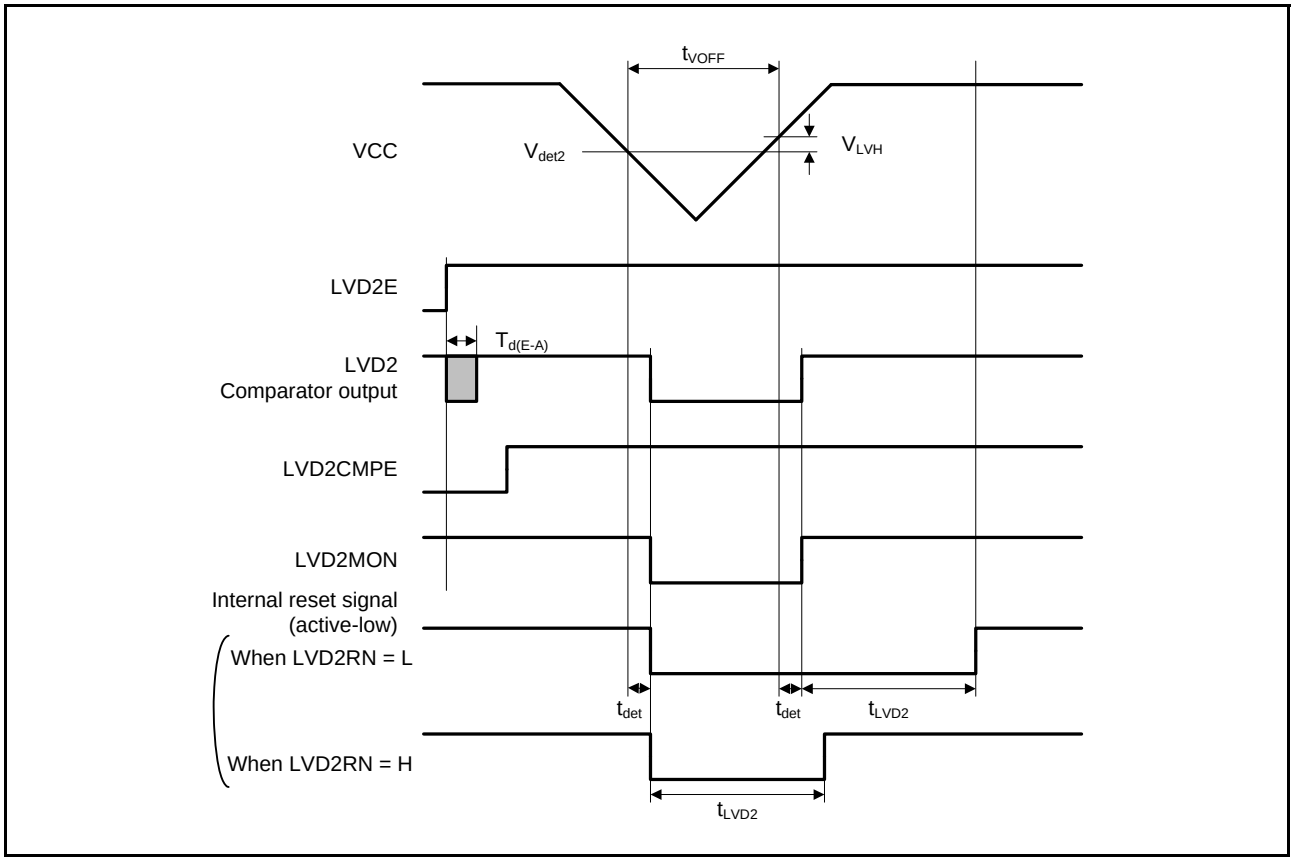


Figure 5.66 Voltage Detection Circuit Timing (V_{det2})

Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update
- Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

Rev.	Date	Description		Classification
		Page	Summary	
1.80	May 13. 2014	Features		
		1	Operating temp. range chaged, Unique ID added	
		1. Overview		
		2 to 7	Table 1.1 Outline of Specifications: Operating temperature changed, Unique ID and Note 2, added	
		8	Table 1.2 Comparison of Functions for Different Packages: Unique ID, added	
		9 to 16	Table 1.3 List of Products, changed and Note 2, added	TN-RX*-A092A/J
		17	Figure 1.1 How to Read the Product Part Number: Operating temperature range, changed	
		19, 23	Table 1.4 Pin Functions: VBATT and USB power pins, changed	
		3. Address Space		
		76	Figure 3.1 Memory Map in Each Operating Mode, changed	TN-RX*-A081A/E
		77	Figure 3.2 Correspondence between External Address Spaces and CS Areas (In On-Chip ROM Disabled Extended Mode), changed	TN-RX*-A081A/E
		5. Electrical Characteristics		
		130	Table 5.1 Absolute Maximum Ratings: Operating temperature, changed	
		131	Table 5.2 DC Characteristics (1): Note 1, chaged	
		133 to 134	Table 5.4 DC Characteristics (3) (for D and G Versions (-40 ≤ Ta ≤ +85°C)): Title	
		135 to 136	Table 5.5 DC Characteristics (4) (for G Version (-85 < Ta ≤ +105°C)), added	
		1921	Table 5.12 Clock Timing (Except for Sub-Clock Related): LOCO changed to LOCO and IWDTCLKB	TN-RX*-A097A/J
		144	Figure 5.6 LOCO, IWDTCLK Clock Oscillation Start Timing, added	TN-RX*-A097A/J
		189	Figure 5.68 Battery Backup Function Characteristics changed	